

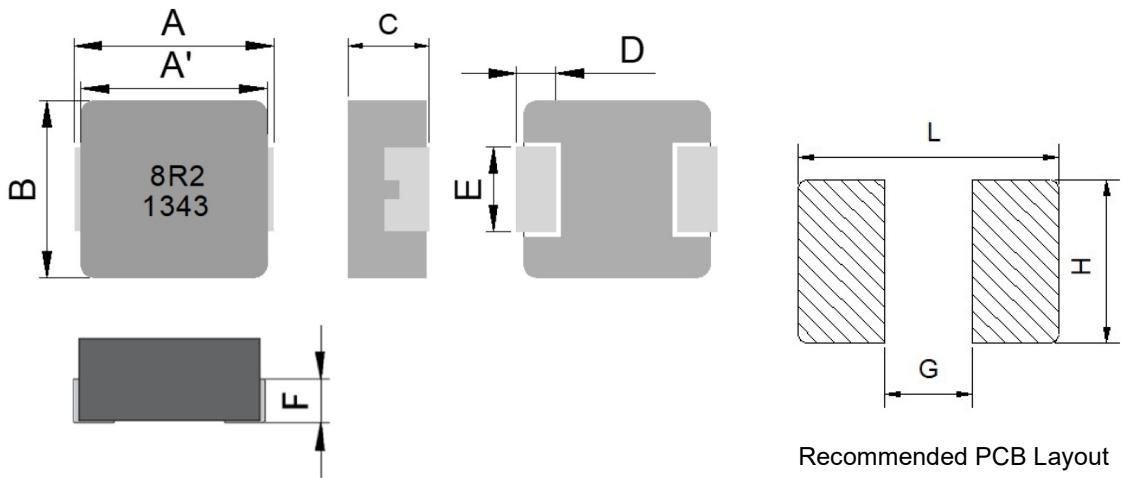
1. Part No. Expression

P I C 0 6 0 3 H 8 R 2 M F

(a) (b) (c) (d) (e) (f)

- | | |
|--------------------|---------------------|
| (a) Series Code | (d) Inductance Code |
| (b) Dimension Code | (e) Tolerance Code |
| (c) Type Code | (f) Packaging Code |

2. Configuration & Dimensions (Unit: mm)

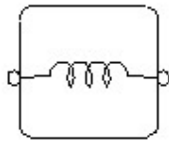


- Note:
1. The above PCB layout reference only.
 2. Recommend solder paste thickness at 0.15mm and above.
 3. Marking: Top= Inductance Code, Bottom=YYWW (Year/World week)

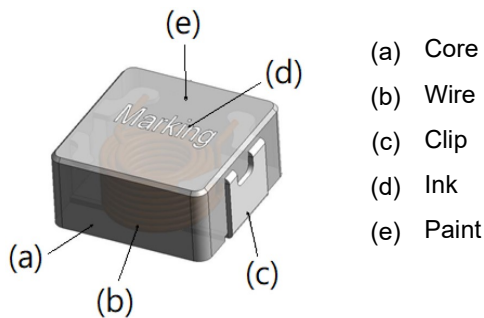
A	A'	B	C	D
7.3±0.3	6.7±0.3	6.6±0.3	2.8±0.2	1.8±0.3
E	F	L	G	H
3.0±0.3	1.6±0.3	8.4 Ref	2.5 Ref	3.5 Ref

NOTE: Specifications subject to change without notice. Please check our website for latest information.

3. Schematic



4. Material List



5. General Specifications

- (a) Operating Temp.: -40°C to +125°C (including self-temperature rise)
- (b) Storage Temp.: -40°C to +125°C (on board)
- (c) All test data referenced to 25°C ambient.
- (d) Heat Rated Current (Irms) will cause the coil temperature rise approximately ΔT of 40°C.
- (e) Saturation Current (Isat) will cause inductance L0 to drop approximately 30%.
- (f) Rated Current: The lower value of Isat and Irms.
- (g) Maximum Operating Voltage: 50V.
- (h) Part Temperature (Ambient + Temp. Rise): Should not exceed 125°C under worst case operating conditions.
- (i) Storage Condition (Component in its packaging)
 - i) Temperature: Less than 40°C
 - ii) Humidity: Less than 60% RH

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6. Electrical Characteristics

Part Number	Inductance (μH) @0A	Inductance Tolerance	DCR (mΩ)		Isat (A)		Irms (A)	
			Typ	Max	Typ	Max	Typ	Max
PIC0603HR10YF	0.10	±30%	1.20	1.70	60.00	55.00	32.50	28.00
PIC0603HR13YF	0.13	±30%	1.30	1.80	50.00	45.00	27.60	24.00
PIC0603HR15YF	0.15	±30%	1.50	1.90	45.00	40.00	27.00	23.00
PIC0603HR16YF	0.16	±30%	1.50	1.90	45.00	40.00	27.00	23.00
PIC0603HR18YF	0.18	±30%	1.70	2.30	43.00	39.00	25.00	22.00
PIC0603HR19YF	0.19	±30%	1.80	2.50	41.00	37.00	24.00	21.00
PIC0603HR20YF	0.20	±30%	1.80	2.50	41.00	37.00	24.00	21.00
PIC0603HR22YF	0.22	±30%	2.10	2.80	40.00	36.00	23.00	20.00
PIC0603HR25MF	0.25	±20%	3.30	3.50	39.00	35.00	21.00	18.00
PIC0603HR33MF	0.33	±20%	3.50	3.90	32.00	28.00	20.00	17.00
PIC0603HR36MF	0.36	±20%	3.60	4.20	32.00	28.00	19.00	16.50
PIC0603HR40MF	0.40	±20%	3.71	4.10	27.50	24.00	18.00	15.50
PIC0603HR47MF	0.47	±20%	4.00	4.20	26.00	23.00	17.50	16.00
PIC0603HR56MF	0.56	±20%	4.70	5.00	25.50	22.50	16.50	15.00
PIC0603HR60MF	0.60	±20%	4.70	5.20	25.50	22.50	16.00	14.50
PIC0603HR68MF	0.68	±20%	4.80	5.50	25.00	22.00	15.50	14.00
PIC0603HR75MF	0.75	±20%	5.50	6.60	24.50	22.00	14.50	13.50
PIC0603HR82MF	0.82	±20%	6.70	8.00	24.00	21.00	13.00	12.00
PIC0603HR90MF	0.90	±20%	8.30	10.00	22.00	19.00	11.00	10.00
PIC0603H1R0MF	1.00	±20%	8.30	10.00	22.00	19.00	11.00	10.00
PIC0603H1R2MF	1.20	±20%	10.00	12.00	20.00	18.00	10.00	9.00
PIC0603H1R5MF	1.50	±20%	13.00	15.00	18.00	17.00	9.00	8.00
PIC0603H1R8MF	1.80	±20%	14.00	17.00	16.00	15.00	8.50	7.50

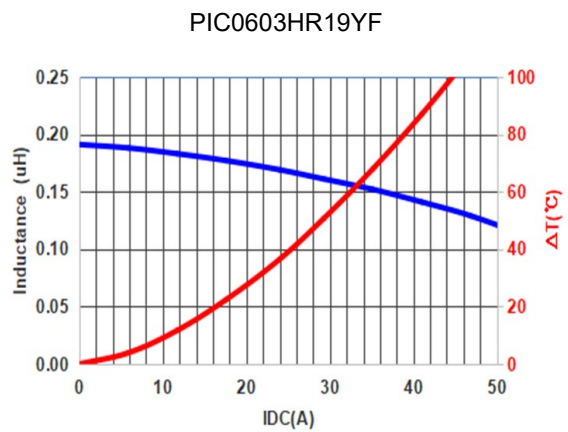
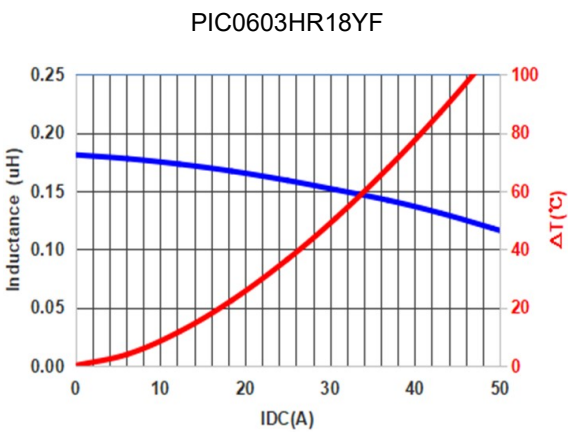
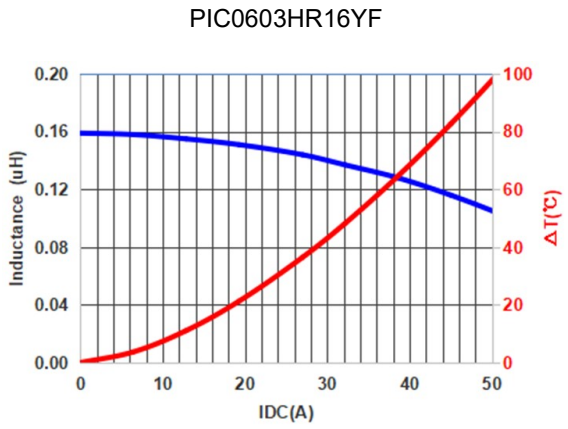
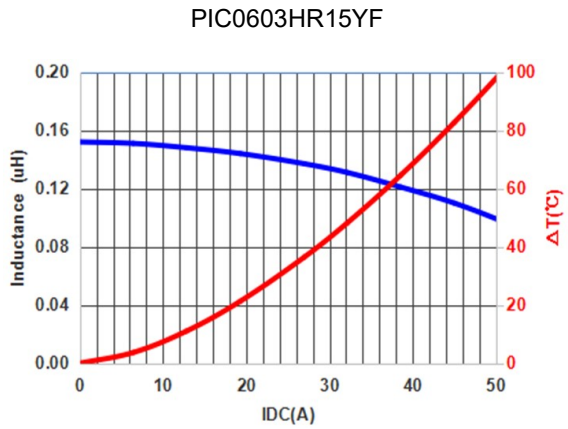
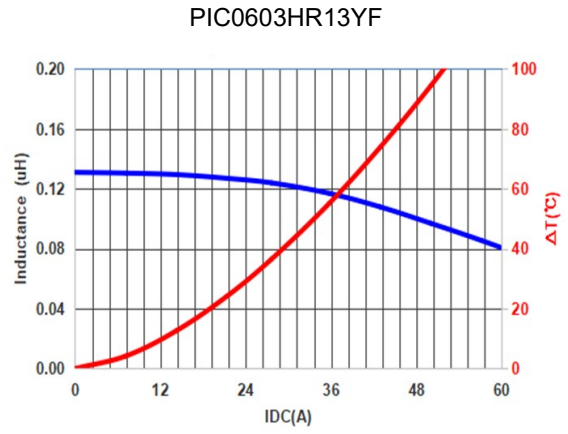
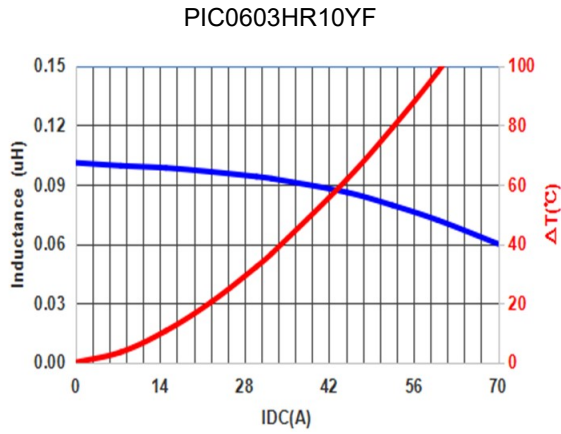
NOTE: Specifications subject to change without notice. Please check our website for latest information.

Part Number	Inductance (μH) @0A	Inductance Tolerance	DCR (mΩ)		Isat (A)		I _{rms} (A)	
			Typ	Max	Typ	Max	Typ	Max
PIC0603H2R0MF	2.00	±20%	16.00	19.00	15.00	13.00	8.20	7.20
PIC0603H2R2MF	2.20	±20%	18.00	20.00	14.00	12.00	8.00	7.00
PIC0603H2R5MF	2.50	±20%	20.00	22.00	13.00	11.00	7.00	6.20
PIC0603H2R7MF	2.70	±20%	24.00	27.00	13.00	11.00	7.00	6.20
PIC0603H3R3MF	3.30	±20%	28.00	30.00	13.50	11.50	6.00	5.30
PIC0603H4R7MF	4.70	±20%	37.00	40.00	10.00	8.50	5.50	4.90
PIC0603H5R6MF	5.60	±20%	43.00	48.00	9.00	8.00	5.00	4.50
PIC0603H6R8MF	6.80	±20%	54.00	60.00	8.00	7.00	4.50	4.00
PIC0603H8R2MF	8.20	±20%	64.00	68.00	7.50	6.50	4.00	3.60
PIC0603H100MF	10.00	±20%	75.00	85.00	6.00	5.00	3.50	3.10
PIC0603H120MF	12.00	±20%	81.00	93.00	5.50	4.50	3.30	3.00
PIC0603H150MF	15.00	±20%	107.00	123.00	4.00	3.20	3.00	2.70
PIC0603H180MF	18.00	±20%	140.00	160.00	4.00	3.20	2.50	2.20
PIC0603H220MF	22.00	±20%	165.00	190.00	3.50	2.90	2.00	1.80
PIC0603H330MF	33.00	±20%	200.00	240.00	2.50	2.20	2.00	1.80
PIC0603H470MF	47.00	±20%	302.00	363.00	2.00	1.70	1.75	1.60

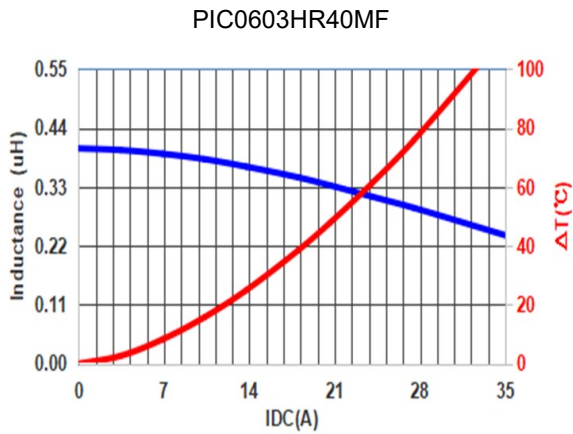
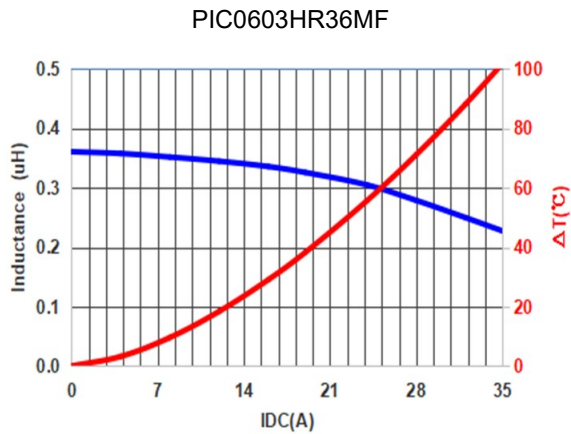
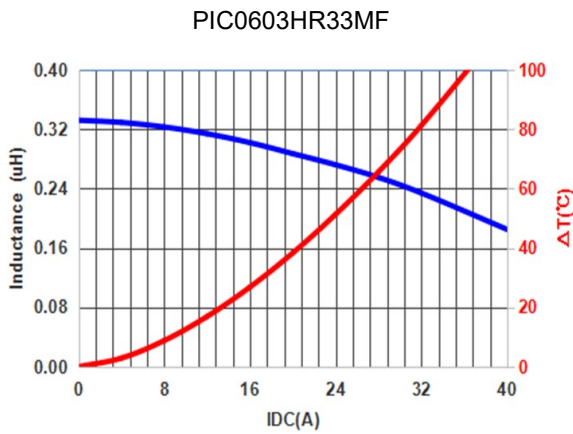
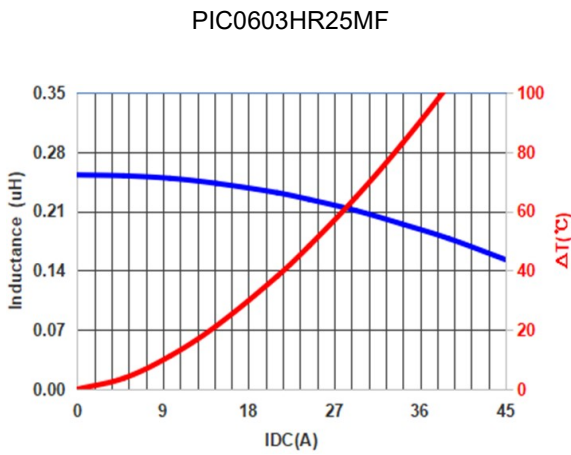
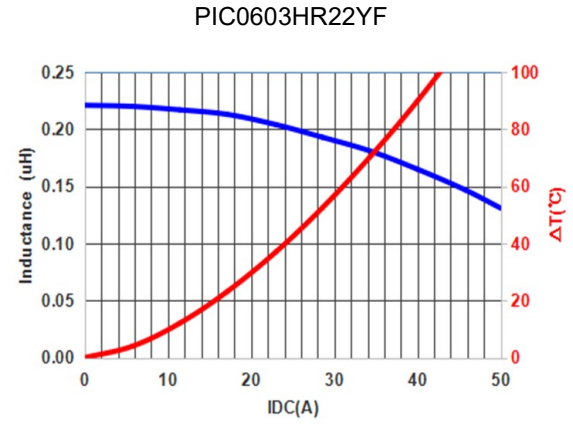
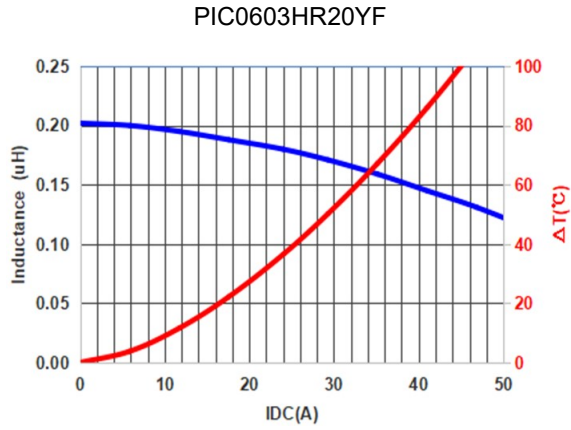
Test Frequency: 1.0V/100kHz

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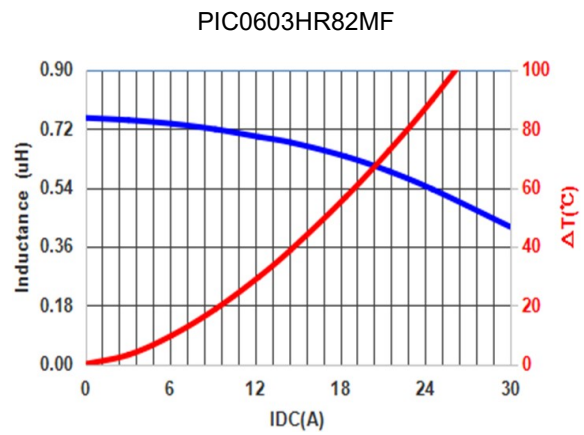
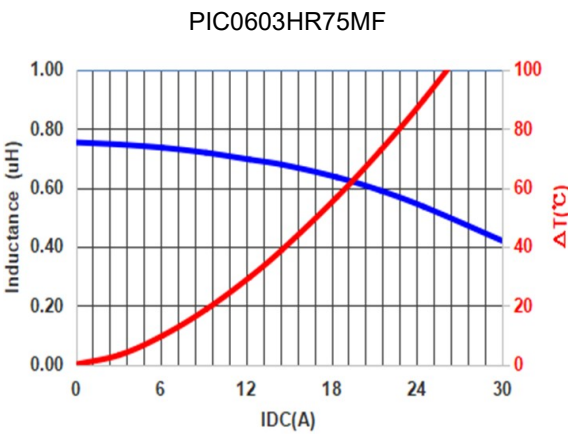
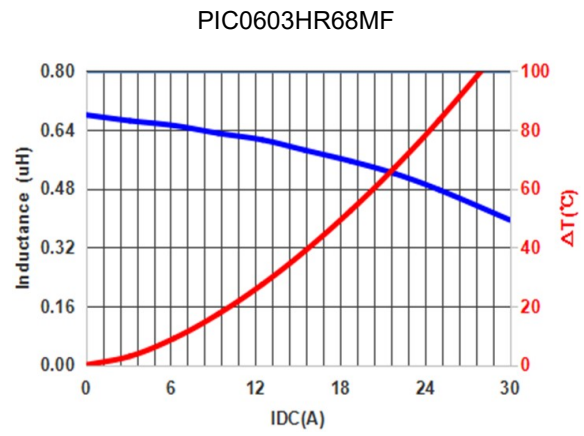
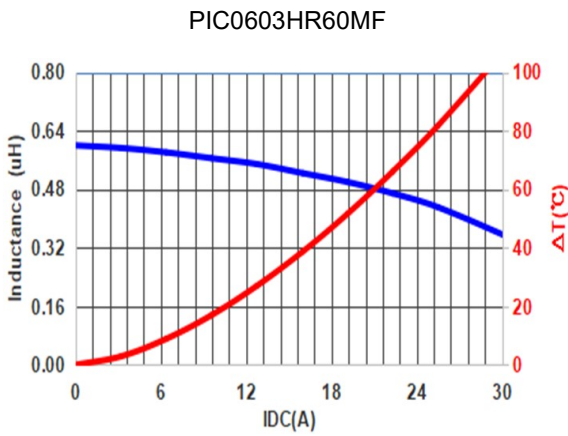
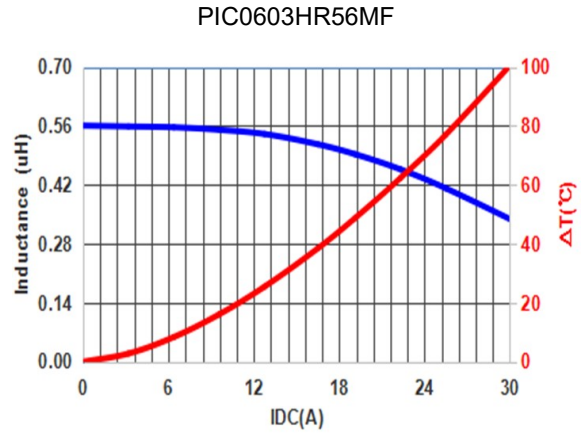
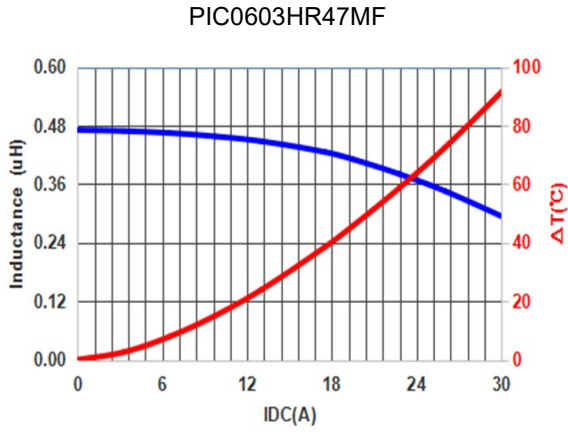
7. Characteristics Curve



NOTE: Specifications subject to change without notice. Please check our website for latest information.

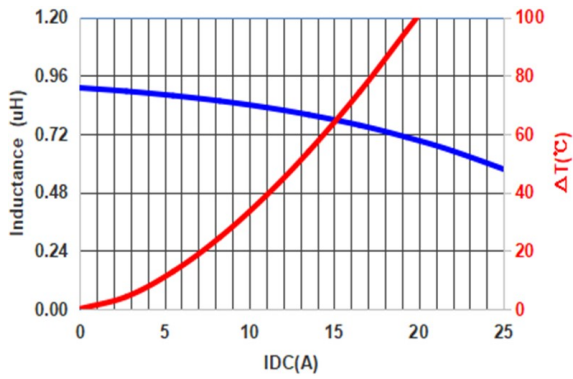


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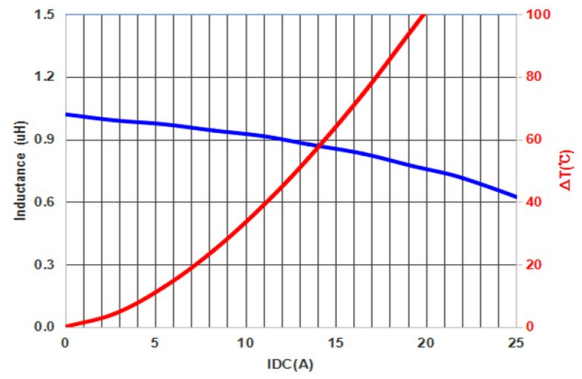


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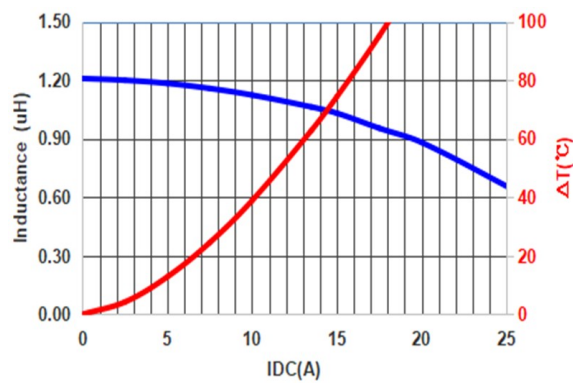
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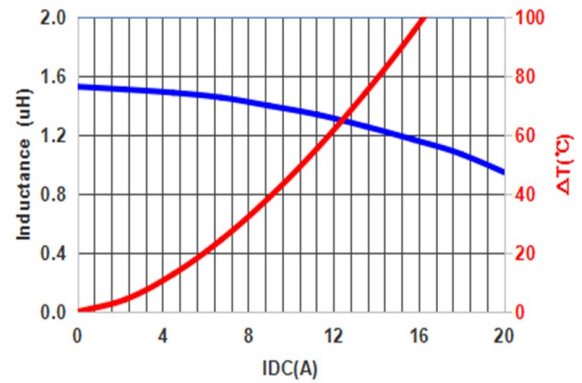
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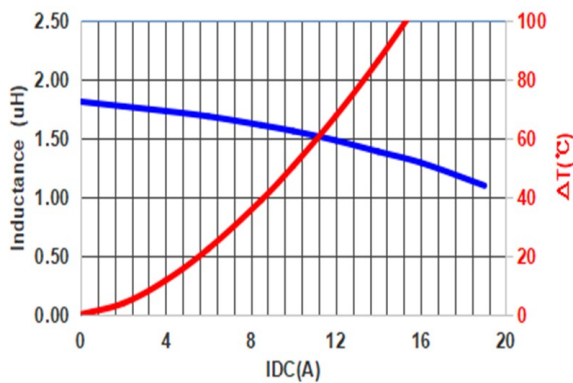
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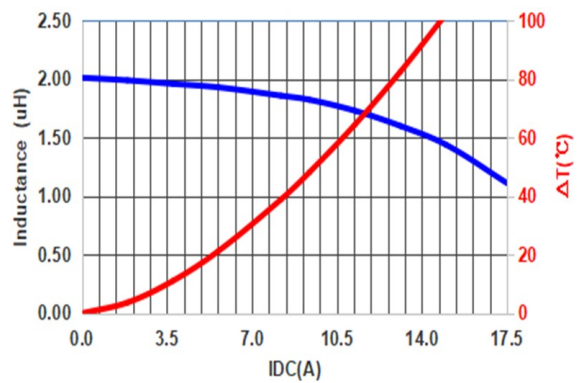
PIC0603H1R5MF



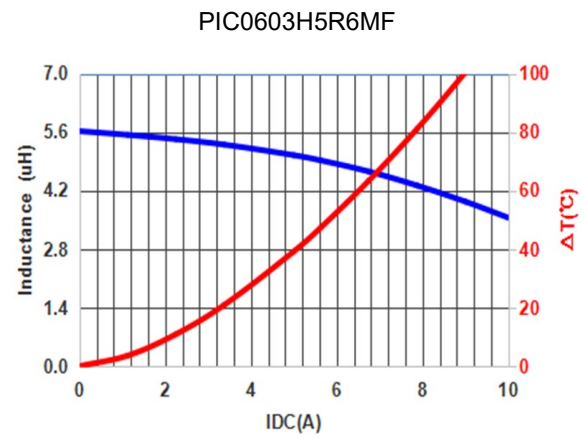
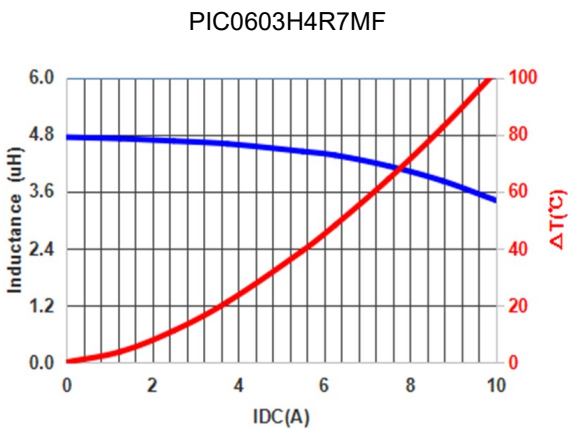
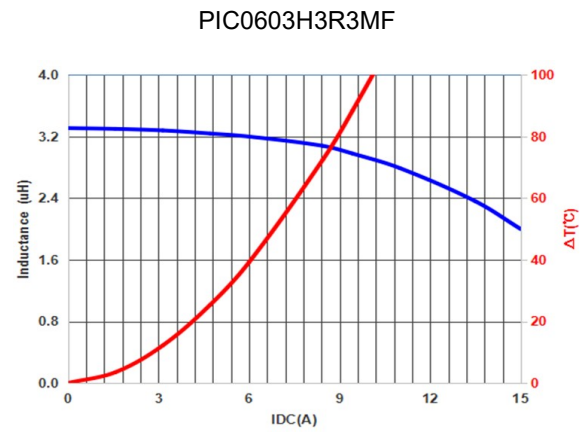
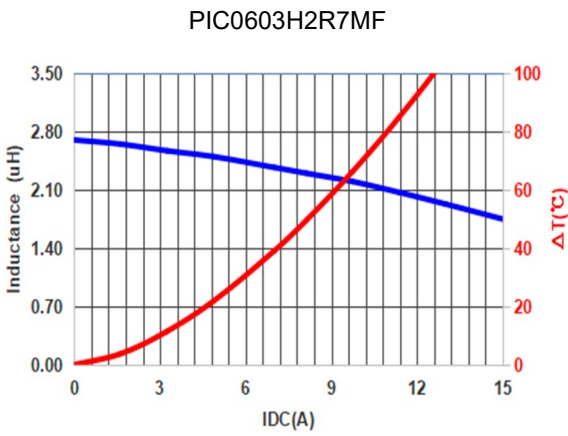
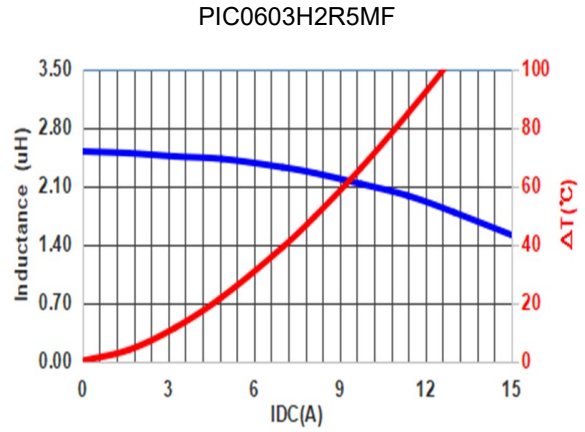
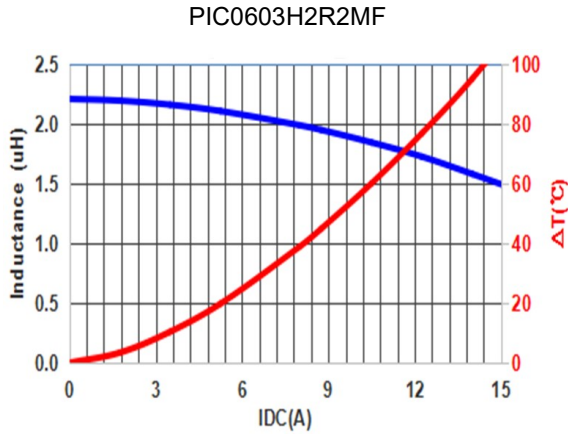
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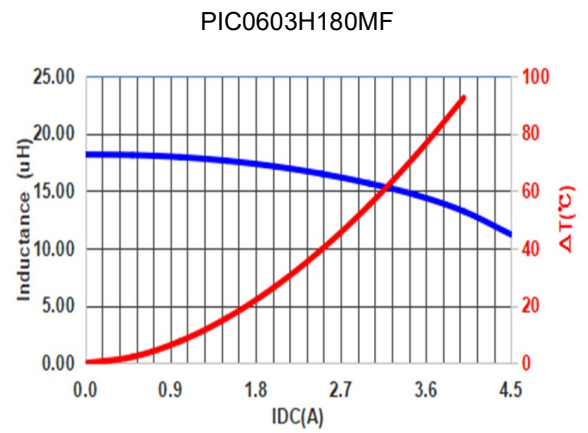
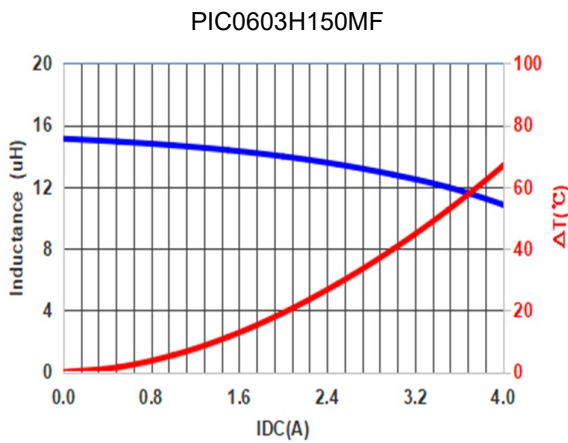
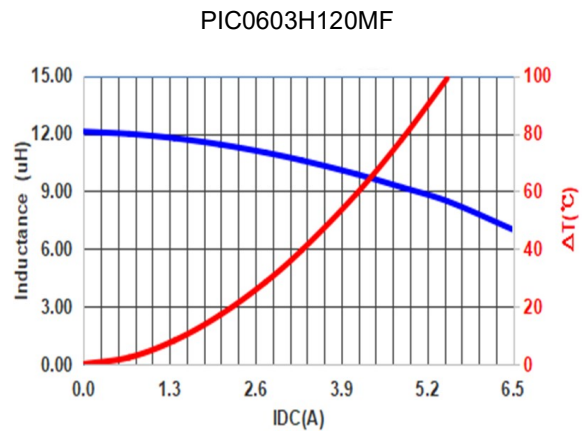
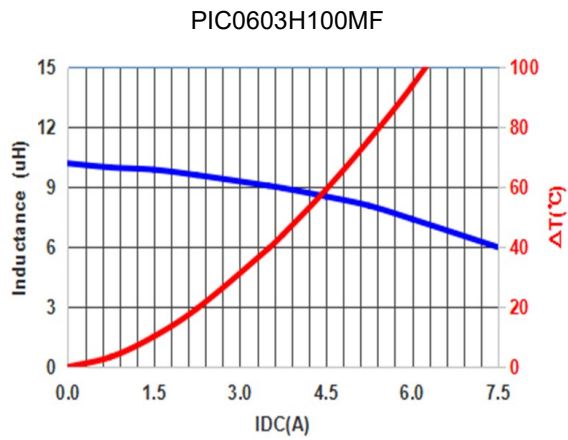
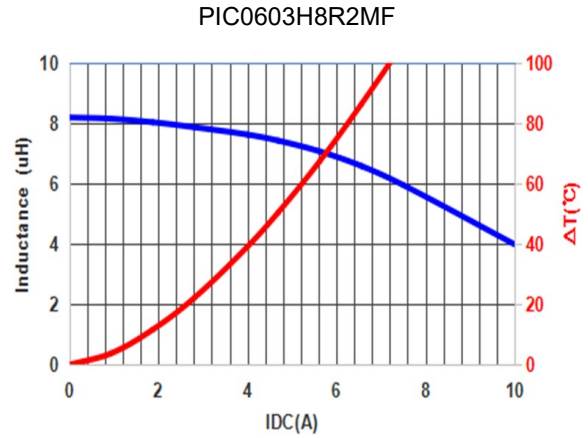
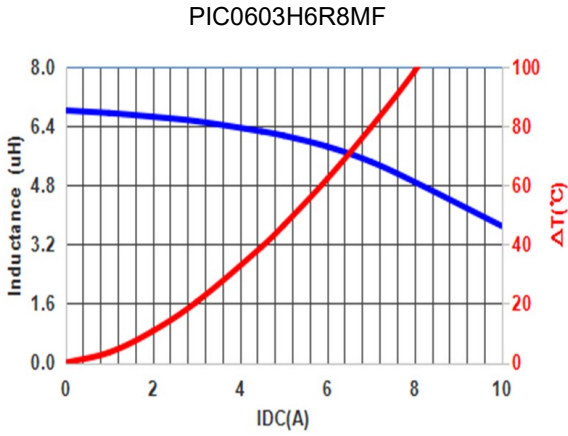
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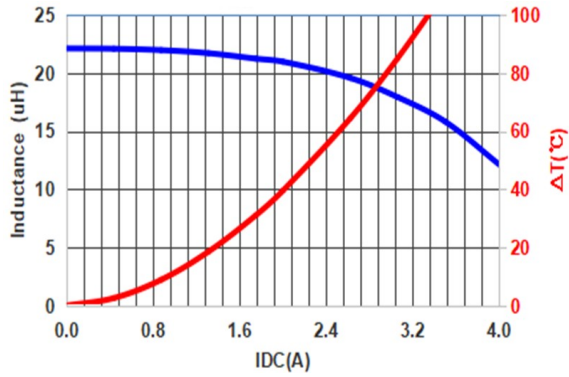


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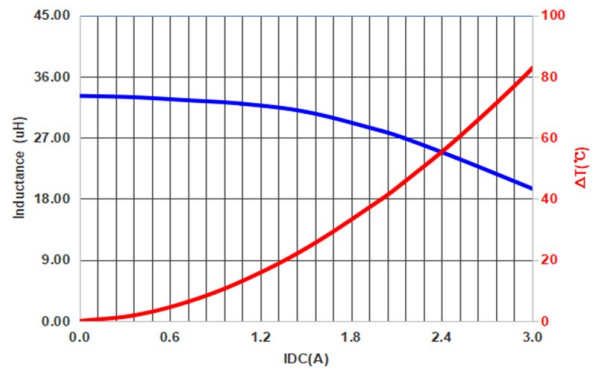


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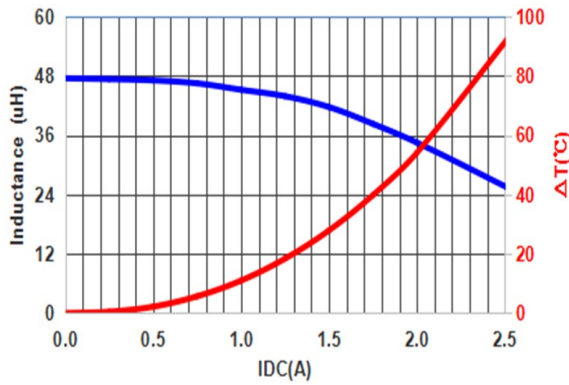
PIC0603H220MF



PIC0603H330MF



PIC0603H470MF



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8. Soldering Specification

Mildly activated rosin fluxes are preferred. Our terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-1. IR Soldering Reflow

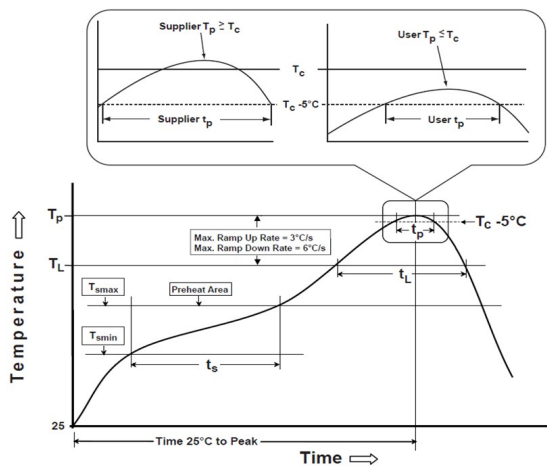
Recommended temperature profiles for lead free re-flow soldering in Figure 1, Table 1.1 & 1.2 (J-STD-020E).

8-2. Iron Reflow

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended (Figure 2).

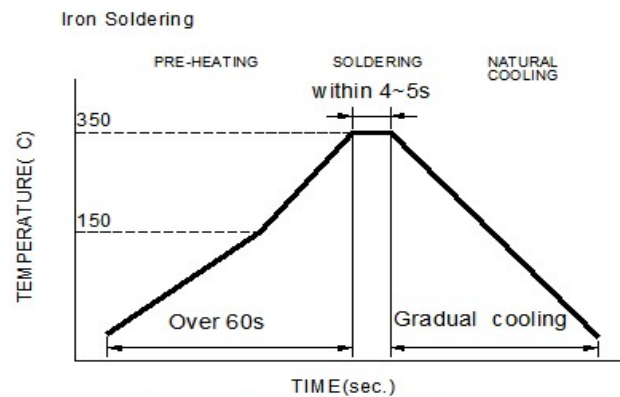
Note:

- (a) Preheat circuit and products to 150°C.
- (b) 355°C tip temperature (Max.)
- (c) Never contact the ceramic with the iron tip
- (d) 1.0mm tip diameter (Max.)
- (e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- (f) Limit soldering time to 4~5 sec.



Reflow times: 3 times Max

Figure 1: IR Soldering Reflow



Iron Soldering times: 1 times max.

Soldering iron method: 350±5°C Max

Figure 2: Iron soldering temperature profiles

NOTE: Specifications subject to change without notice. Please check our website for latest information.

Table (1.1) Reflow Profiles

Profile Type:	Pb-Free Assembly
Preheat	
-Temperature Min (T_{smin})	150°C
-Temperature Max (T_{smax})	200°C
-Time (t_s) from (T_{smin} to T_{smax})	60-120seconds
Ramp-up rate (T_L to T_p)	3°C /second max.
Liquids temperature (T_L)	217°C
Time (t_L) maintained above T_L	60-150 seconds
Classification temperature (T_c)	See Table (1.2)
Time (t_p) at $T_c - 5^\circ\text{C}$ (T_p should be equal to or less than T_c .)	* < 30 seconds
Ramp-down rate (T_p to T_L)	6°C /second max.
Time 25°C to peak temperature	8 minutes max.

T_p: maximum peak package body temperature, **T_c**: the classification temperature.

For user (customer) **T_p** should be equal to or less than **T_c**.

*Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

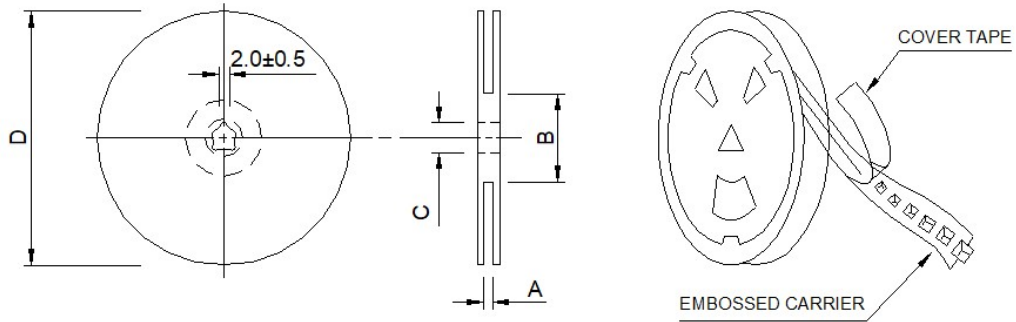
	Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
PB-Free Assembly	<1.6mm	260°C	260°C	260°C
	1.6-2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

Reflow is referred to standard IPC/JEDEC J-STD-020E.

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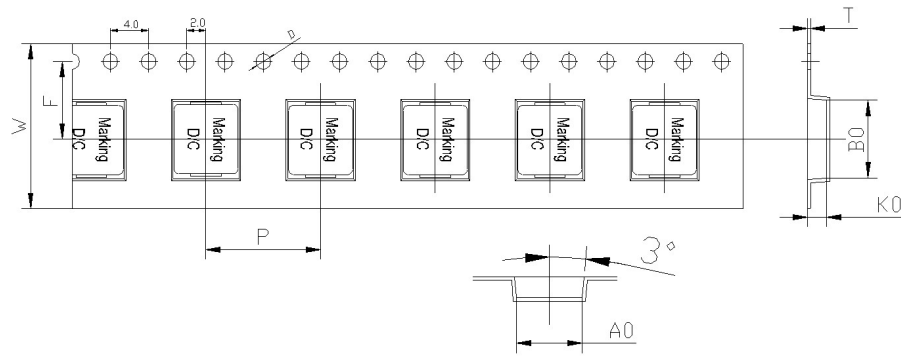
9. Packaging Information

9-1. Reel Dimension (Unit: mm)



Type	A	B	C	D
13" x 16mm	16.4+2.0/-0.0	100.0±2.0	13.0+0.5/-0.2	330.0

9-2. Tape Dimension (Unit: mm)



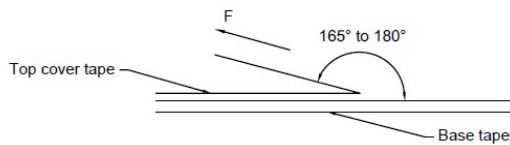
B0	A0	K0	P	W	F	T	D
7.70±0.10	7.00±0.10	3.30±0.10	12.00±0.10	16.00±0.30	7.50±0.10	0.35±0.05	1.50±0.10

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9-3. Packaging Quantity (Unit: Pcs)

Chip/ Reel	1,000
Inner Box	2,000
Carton	8,000

9-4. Tearing Off Force



The force for tearing off cover tape is according to the follow table, in the arrow direction under the following conditions.

(Referenced ANSI/EIA-481-D-2008 of 4.11 standard)

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed (mm/min)
5~35	45~85	860~1060	300±10

Tape Size	8 mm	12 to 56 mm	72 mm or Wider
Tearing Off Force (grams)	10~100	10~130	10~150

Application Notice

1. Storage Conditions

To maintain the solderability of terminal electrodes:

- (a) Recommended products should be used within 12 months from the time of delivery.
- (b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation

- (a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- (b) Vacuum pick up is strongly recommended for individual components.
- (c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

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